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IN THE UNITED STATES PATENT AND TRADEMARK OFFICECOPY OF PAPERS  
ORIGINALLY FILED

INVENTOR: Densen Cao

DOCKET: 5061 P

TITLE: IMPROVED SEMICONDUCTOR CURING LIGHT SYSTEM USEFUL FOR  
CURING LIGHT ACTIVATED COMPOSITE MATERIALS

FILED: December 13, 2001

SERIAL NO.: 10/017,454

ASSIGNEE: Cao Group, Inc.

Assistant Commissioner for Patents  
Washington, DC 20231

## DECLARATION FOR PATENT APPLICATION

As the below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name.

I believe I am the original, first and sole inventor of the subject matter which is claimed and for which a patent is sought on the invention entitled with the Title listed above and filed on December 13, 2001 and assigned serial no. 10/017,454. I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims. I acknowledge the duty to disclose information that is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, Section 1.56(a).

I hereby appoint Daniel P. McCarthy (Reg. No. 36,600), Lloyd W. Sadler (Reg. No. 40,154), David S. Romney (Reg. No. 24,266), Jon C. Christiansen (Reg. No. 30,039), James L. Sonntag (Reg. No. 30,224), Vanessa B. Pierce (Reg. No. 42,274), Alison B. Mohr (Reg. No. 48,170), and Everett Robinson (Reg. No. 50,911) my representatives and attorneys to prosecute this application and to transact all business in the Patent and Trademark Office connected therewith. All communications should be directed to Mr. McCarthy at the following address or telephone number:

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I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of

the application or any patent issued thereon.

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2/28/02

10017454-032002